A+M Data Center Activities in National Fusion Research Institute

Mi-Young Song with Team Members

Plasma Technology Research Center National Fusion Research Institute







Overview of A+M Data Center Activities in NFRI

A+M Data research on the plasma fundamental data

Future Research Plan

Summary





Combination Molecules

in Fusion Plasma





Missions

1. Research of plasma Fundamental data

- Molecular structure, Physical and Chemical parameters
- Electron collision processes with Molecules
- Plasma characteristics diagnostic studies
- Surface reactions related data necessary to study the plasma process analysis
- Data evaluation

2. Development of plasma modeling and simulator

- Developing a multi-dimensional simulator for low-temperature plasma analysis
- Development of plasma fluid model based on multi-dimensional simulator for analysis equipment
- Development S / W for the data optimization.

3. Activities for the dissemination of data

- Date collection and dissemination
- International collaboration for data evaluation and production
- · Developing user-friendly web system



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Plasma Fundamental Data??







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Summary



A+M Data research on the plasma fundamental data

- 1. <u>Research on Molecular Structure, Physical and</u> <u>Chemical Parameters</u>
- 2. Electron collision processes with Molecules
- 3. Research on Plasma characteristics
- 4. Surface reactions related data necessary to study the plasma process analysis
- 5. Data evaluation



Fundamental data for plasma simulation

Application	Parameter, equation, or model	Fundamental Data needed
Plasma simulator	Average gas temperature ¹	$C_p{}^0$ (Heat capacity, <i>Jmol</i> ⁻¹ K ⁻¹)
		H^0 (Enthalpy, $kJmol^{-1}$)
	 Viscosity in thermal conductivity eq.¹ Diffusion coefficient for binary gas system² 	$\boldsymbol{\sigma}$ (characteristic length, \hat{A})
	 Diffusion collision integral in thermal conductivity eq.¹ Diffusion collision integral in Diffusion coefficient ² 	\mathcal{E} (characteristic energy, K)
	Ion-ion mutual neutralization rate (Hickman's formulation) $k = 5.33 \times 10^{-7} \left(\frac{T}{300}\right)^{-0.5} \mu^{-0.5} (E.A.)^{-0.4}$	EA (electron affinity, eV)
	Ion-molecule charge transfer rate (Langevin's theory) $k_L = 2.34 \times 10^{-9} \sqrt{\frac{\widetilde{\alpha}}{\widetilde{\mu}}} \ cm^3/s$	α (polarizability, 10 ⁻²⁴ cm ³)
	Ion momentum transfer collision frequency ³	\mathcal{E}_{iZ} (ionization energy, eV)
	Chemical reaction rate constant, k (Transition state theory) $k^{GT} = \sigma \frac{k_b^T}{h} \frac{Q^{TS}(T,s)}{N_A Q^R(T)} e^{(-V^{\dagger}(s)/k_b^T)}$	V [*] (activation barrier, <u>a.u.</u>)
Total ionization	Binary-Encounter-Bethe (BEB) model	B (electron binding energy, eV)
C1055 Section5	$\sigma_{\text{BEB}} = \frac{S}{t+u+1} \left[\frac{\ln t}{2} \left(1 - \frac{1}{t^2} \right) + 1 - \frac{1}{t} - \frac{\ln t}{t+1} \right]$	$oldsymbol{U}$ (average kinetic energy, $e oldsymbol{ u}$)
	$t = T / B$, $u = U / B$, $S = 4 \pi a_0^2 N (R / B)^2$ $a_0 = 0.5292 \text{ Å}$, $R = 13.60 \text{ eV}$	N (electron occupation number)







Chemical Reaction Tree



FIG. 1. Schematic of electron impact reactions in $c-C_4F_8$. The thickness of arrows represents the value of reaction rates calculated for an ICP at 6 mTorr, 600 W, 13.56 MHz.

Kushner et al., J. Vac. Sci. Technol. A, 22, 511 (2004)





Thermodynamic data and LJ Parameters

- ✓ <u>Production of Phys. & Chem. Property Data for Improving Plasma Simulator</u>
 - 1). Average gas temperature equation



(1) Heat capacity at constant pressure(2) Enthalpy

QC cal. with
G09

$$H = E + RT$$

 $E = E_0 + E_{vib} + E_{rot} + E_{transl}$
 $E_0 = E_{elec} + ZPE$



(3). Thermal conductivity of a gas mixture at low density

 \rightarrow

$$\kappa = \sum_{\alpha=1}^{N} \frac{x_{\alpha} k_{\alpha}}{\sum_{\beta} x_{\beta} \Phi_{\alpha\beta}}$$

$$\Phi_{\alpha\beta} = \frac{1}{\sqrt{8}} \left(1 + \frac{M_{\alpha}}{M_{\beta}} \right)^{-1/2} \left[1 + \left(\frac{\mu_{\alpha}}{\mu_{\beta}} \right)^{1/2} \left(\frac{M_{\alpha}}{M_{\beta}} \right)^{1/4} \right]^2$$

with k_{α} = thermal conductivity of α species, $cal / cm \cdot s \cdot K$ x_{α} = mole fraction of α species $\Phi_{\alpha\beta}$ = dimensionless quantitiy μ = viscosity T = temperature, KM = molecular weight

- σ = charteristic length, A
- Ω_k = diffusion collision integral, dimensionless





3). Diffusion coefficient for binary gas systems at low pressure

$$D_{ij} = 1.858 \times 10^{-3} T^{3/2} \frac{\left[\left(M_i + M_j \right) / M_i M_j \right]^{1/2}}{p \sigma_{ij}^2 \Omega_D}$$

with $D_{ii} = \text{diffusion coefficient}, cm^2/\text{sec}$

T =temperature, K

p = pressure, atm

- σ = charteristic length, A
- Ω_D = diffusion collision integral, dimensionless









Physical parameters

5). Ion-ion mutual neutralization rate : Hickman's formulation $k = 5.33 \times 10^{-7} \left(\frac{T}{300}\right)^{-0.5} \mu^{-0.5} (E.A.)^{-0.4}$ $A^+ + B^- \rightarrow A + B$ T = temperature, K μ = reduced mass, *amu* E.A = electron affinity, eV6). Ion-molecule charge transfer rate : Langevin's theory $k_L = 2.34 \times 10^{-9} \sqrt{\frac{\widetilde{\alpha}}{\widetilde{\mu}}} \ cm^3/s$ $A^+ + B \rightarrow A + B^+$ (α) = polarizability, 10⁻²⁴ cm³ 7). Ion momentum transfer collision frequency with species N $V_{iN} = n_N (\sigma_L + \sigma_{ex}) U_i$ where $\sigma_L = 2\pi e_V \left| \frac{\alpha}{m_i} \frac{1}{v_i}, \sigma_{ex} = 8 \frac{\pi e^4}{\varepsilon_{ix}^2} \right|$ ε_{iZ} = ionization energy, eV



L-J Parameters & Thermodynamic Data obtained at the ωB97X-D/avtz level

- CxFy plasma species -

Symbol	Molecular Weight [kg/kmol]	Polarizability [angstroms^3]	Ionization Energy [eV]	Electron Affinity [eV]	note
C3F2					
C3F2		4.887	9.556	0.449	c-C3F2
		5.889	10.294	1.879	CCCF2
C3F3					
C3F3	93.0273	6.253	8.636	1.975	FCCCF2
		5.459	10.069	2.856	c-CCFCF2
		5.372	8.315	1.360	c-C3F3
C3F3+	93.0273	5.220	-	-	FCCCF2 +
		same with FCCCF2+	-	-	c-CCFCF2+
		4.352	-	-	c-C3F3+
C3F3-	93.0273	8.614	-	-	FCCCF2-
		7.378	-	-	c-CCFCF2-
		8.820	-	-	c-C3F3-
C3F4					
C3F4		6 324	10 11 3	0 559	E2CCCE2
		5.696	11 099	-0.795	ECCCE3
		5 401	10.824	0.755	c-C3F4
		5.101	10.02 1		
C3F5					
C3F5	131.043	6.488	7.317	1.246	F2CCFCF2
		6 197	10 706	2 881	F2CCCF3
		6.108	10.995	2.656	F3CCECE
C3F5+	131.043	6.107	-	-	F2CCFCF2+
		6.107	-	-	F2CCCF3+
		5.622	-	-	F3CCFCF+
0356					
C3F6		C 207	0.070	0.220	FACCECER
COFO		0.397	9.672	0.239	- C256
		5.974	10.993	-1.132	C-CSF6
C4F3					
C4F3		8,195	8.577		F2CCCCF
		8.589	9.540	3.259	F2CFCCC
		7.191	7.972	1.720	c-C4F3
C4F5					
C4F5	143.035	8.184	7.972	2.108	F2CCCCF3
		7.365	7.991	1.940	c-C4F5
		8.662	7.844	2.149	F2CCCFCF2

- In the case of NF₃



Dimon	MP2	l/avtz	ωB97X-D/avtz			
Dimer	σ	3	σ	3		
1	3.28	0.534	3.36	0.472		
2	3.98	0.592	4.08	0.551		
3	3.34	0.217	3.43	0.195		



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Measurement of Total scattering cross section



- Measurement of electron scattering cross section using magnetized electron
- Surko at UCSD has developed a positron system based on Malmberg-Penning trap.
- ANU group has adapted the idea to electron system.
- ANU-NFRI-CNU have been closely collaborating to realize this idea.
- We will present the progress made on the Korean side only, even though the ANU group has made more meaningful progresses.



플라즈마물성데이터센터 Data Center for Plasma Properties

- Use of the invariance of E_{\perp}/B
- Use of the variable magnetic field ratio M = B₁/B₂



The total cross section σ in calculated from de Beer – Lambert attenuation formula





Measurements can be done by monitoring alternatively I_0 (without gas in the scattering cell) and the current I with gas in the scattering cell, with the known pressure p and T, averaging over a number of such pairs for every scattering energy E





CH1 = 9.2E-06 Torr B/G = 0.35 mTorr

Wehnelt = Pierce [V] Pierce = 0 V(에너지 대비) Aperture1 = -1 V Aperture2 = GND RPA1 = GND Gas Cell = GND Filament Current = 1.86 A Coil Current = 10.0 A











Electron-Impact Total Ionization Cross Sections of CxFy





The 6th China- Japan-Korea Joint Seminar on Atomic and Molecular Processes in Plasma





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Research on the processing plasma DB

ICP system(13.56 MHz) CCP system (13.56 MHz) **Cut-off Probe** CCF HPR ICP EQP

Diagnostics Lists

- QMS
- Cut-off probe

- HPR
- OES
- Cut-off probe
- Langmuir probe
- EQP





Plasma diagnostics in ICP - Ion densities in fluorocarbon plasmas were measured by Quadrupole Mass Spectroscopy (Pfeiffer Vacuum, PPM422)





QMS data of FC1/FC2 mixture







- ✓ Diagnostics of ion and neutral radical of the mass and the energy for plasma simulation and modeling
- ✓ <u>RIE Mode and PE Mode</u>
 - Mass scan

Energy scan





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- Surface reaction modeling for plasma etching processes
 - Development of Fluorocarbon(FC) & Hydrogenic fluorocarbon(HFC) plasma etching processes modeling
- Discovering surface reaction mechanism
 - Measurement of etch rate of SiO2/ SiN2 using Fluorocarbon(FC)
 & Hydrogenic fluorocarbon(HFC)
 - Analysis of relation between ratio Measured ion and radical species and etch rate in each case
- Construction of Database of surface reaction and rate coefficient about Si, SiO2, SiN2



- Measurement of etch rate of SiO2/ SiN2 input Fluorocarbon(FC) & Hydrogenic fluorocarbon(HFC)
- Variation condition (gas mixture, pressure, power)

Mixture	Data Set [*]	Pressure	Source power (W _s)	Bias power (W _B)		
FC1 mixture	10 case	10 ~ 30 mTorr	300 ~ 700 W	0 ~ 350 W		
FC2 mixture	6 case	10 ~ 30 mTorr	300 ~ 500 W	0 ~ 350 W		
HFC1 mixture	6 case	10 ~ 30 mTorr	300 ~ 500 W	0 ~ 350 W		
FC1/FC2/HFC1 mixture	12 case	10 ~ 30 mTorr	300 ~ 500 W	0 ~ 350 W		



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Preparatory stage

- Review of previous evaluation paper
- Collection of new paper.
- Define working Scope
- Contents of report
- To shard working part



Evaluation

stage

- analysis method of experiment and theory (characteristics, limitation, uncertainty, method)
- Comparisons of different research group
- Combine different collision processes



- Check uncertainty
- Define recommended data of each collision processes
- Agreement of each evaluator











Evaluated data (2007 ~ 2015)

	구분	total scatt ering	eleastic so attering	momentu m transfer	DCS	total ioniz ation	partial ion ization	TDCS	Neutral di ssociation	Total atta chment	Dissociati ve attach ment	vibrationa I excitatio n	rotational excitation	electronic al excitati on
		TCS	ES	MT	DCS	TICS	PICS	TDCS	NDCS	TACS	DACS	VI	RO	EX
1	H2	С	V	V	D	Q	Q			Q		V	Q	Q
2	O2	Q	Q	Q	D	Q	V	Q			V	Q		V
3	N2	Q	Q	V	D	Q	V	Q				Q	Q	Q
4	Ar	V	Q	Q	D	V	V							
5	Xe	V	Q	Q	D	V	V							
6	CF4	V	V	V	V	V	Q	Q	Q	Q				
7	C2F6	V	Q	Q	V	V	V	Q		Q				
8	C3F8-2013	V	Q	Q	V	V	Q	Q		Q				
9	C4F8-2013	V	V	V	V	Q	Q	Q		Q				
10	CF3I-2013	V			D	Q	Q							
11	CHF3		V	V	D	V	Q	Q						
12	CCI2F2	Q	Q		D	V	Q							
13	SF6	V	Q	Q	D	Q	Q							
14	CCl4	V			D	V	V							
15	SiF4	V			D	Q	Q		Q					
16	SiF3					Q	Q							
17	SiF2					Q	Q							
18	SiF					Q	Q							
19	Si					Q	Q							
20	SiH4	V	Q	Q	D	V	V	Q						
21	Si2H6	Q	Q	Q	D			Q						
22	NF3	Q	Q	Q	D	Q	Q				Q			
23	NH3	V	Q	Q	D	Q	Q							
24	N2O					V	Q			Q	Q			
25	NO2					Q	Q							
26	NO		Q			Q	Q			Q				
27	С					Q	Q							
28	0					Q	Q							
29	N					Q	Q							
30	F					Q	Q							
31	Cl					Q	Q							
32	Br					Q	Q							



	구분	total scatt ering	eleastic sc attering	momentu m transfer	DCS	total ioniz ation	partial ion ization	TDCS	Neutral di ssociation	Total atta chment	Dissociati ve attach ment	vibrationa I excitatio n	rotational excitation	electronic al excitati on
		TCS	ES	MT	DCS	TICS	PICS	TDCS	NDCS	TACS	DACS	VI	RO	EX
33						Q	Q							
34	CFx				Q		Q							
35	NFx						Q							
36	SFx					Q	Q							
37	C2F4	Q	Q	Q	V	Q						Q		
38	F2					Q	Q				Q			
39	Cl2	V				V	Q							
40	BCI3	Q				Q	Q							
41	СО	V	V	Q	D	V	V				Q	Q	Q	Q
42	CO2	V	V	Q	D	V	V				Q	V		Q
43	CF3CI-2013	V	Q			V	Q							
44	CFCI3	Q					Q							
45	BF3	Q				Q					Q			
46	CS2	Q	Q			Q	Q				Q			
47	SO2	Q	Q	Q	D	V	Q	Q			Q			
48	CH3I	Q				Q	Q							
49	CH3Br	Q				Q	Q							
50	CH3CI	Q				Q	Q							
51	CH3F	Q				Q	Q							
52	GeH4	Q	Q	Q	D									
53	GeF4	Q												
54	GeCl4	Q												
55	H2S	V	Q	Q	D	Q	Q							
56	SO					Q	Q							
57	HCI	Q									Q			
58	CS						Q							
59	S2						Q							
60	CH2F2				D	Q	Q							
61	O3					Q	Q							
62	SiCl4	Q			D	Q	Q							
63	SiClx					Q	Q							
65	S					Q	Q							
66	Ge					Q	Q							
67	SiDx						Q							
68	CH4	V	V	V	V	V	Q			Q	Q	Q		
69	C2H2													



Group evaluation project

- This work decide at the Joint IAEA-NFRI Technical Meeting (TM) on Data Evaluation for Atomic, Molecular and Plasma Material Interaction Processes in Fusion in September 2012
- Participants recommended group member and molecule at that time.
- Group Members:
 - Y. Itikawa (Japan)
 - Grzegorz P. Karwasz (Nicolaus Copernicus University),
 - J. Tennyson (University College London)
 - Viatcheslav kokoouline(University of Central Florida)
 - H. Cho(Chung-Nam National University)
 - Y. Nakamura (Tokyo Denki University)
 - J.-S. Yoon, M.-Y. Song (National Fusion Research Institute)
- Our purpose: To establish the internationally agree standard reference data library for AM/PMI data



- 1st GM : 23 25 January 2013, Gunsan, South Korea
- ✓ 2nd GM : 25 -27 June 2013, Deajeon, South Korea
- ✓ 3rd GM : 23-24 September 2013, Open university. UK
- ✓ 4th GM : 8-9 January 2014, Seoul, South Korea
- ✓ 5th GM : 4 -5 July 2014, Cumberland Lodge, UK
- 6th GM : 14 December 2014, Deajeon, South Korea
- 7th GM : 14-15 May 2015, University College London, UK
- 8th GM : 17-19 November 2015, Ramada hotel & Suite Seoul Namdaemun, Seoul, Korea
- 9th GM : 13-16 May 2016, University College London, UK
- ✓ 10th GM: 27 September 2016, NFRI, South Korea







Cross Sections for Electron Collisions with Methane

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Cross section data are compiled from the literature for electron collision (CH₄) molecules. Cross sections are collected and reviewed for total sca scattering, momentum transfer, excitations of rotational and vibrational state ionization, and dissociative attachment. The data derived from swarm exper considered. For each of these processes, the recommended values of the crc presented. The literature has been surveyed through early 2014. © 2015 / ULC [http://dx.doi.org/10.1063/1.4918630]

Cross Sections for Electron Collisions with Acetylene

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 (Revised 18 November 2015)

Cross section data are compiled from the literature for electron collisions with acetylene (HCCH) molecules. Cross sections are collected and reviewed for total scattering, elastic scattering, momentum transfer, excitations of rotational and vibrational states, dissociation, ionization, and dissociative attachment. The data derived from swarm experiments are also considered. For each of these processes, the recommended values of the cross sections are presented. The literature has been surveyed through early 2016.

PACS numbers: 34.80.Bm, 52.20.Fs Keywords: electron collisions, total cross sections, ionization, dissociation, attachment, evaluation

I. INTRODUCTION

Acetylene (HCCH) is the

The accuracy for the measured cross section data for processes involving ground state species is

II. TOTAL SCATTERING CROSS SECTION

II. ELASTIC SCATTERING CROSS SECTION

Since the last review of electron-acetylene collisions by Nakamura¹, theoretical cross sections for excitation of

IV. MOMENTUM TRANSFER CROSS SECTION

The momentum-transfer cross-section for electronacetylene collisions has been determined in several recent studies in which elastic differential cross sections were measured or calculated. Similarly to the recommended data for differential elastic cross sections discussed above, the recommended momentum-transfer cross section is from the recent study by Gauf et al.³. The agreement of the data by Gauf with a previous experimental work by Iga et al.⁴ is very good. Theoretical cross sections determined in the same work by Gauf et al.³, and also by Jain⁵, and Gianturco and Stoecklin⁶ agree with each other within 5-10% above 1 eV. However, they are larger than experimental data by about 20% over the whole



Future Research Plan

- 1. To make complex set of thermodynamics and physical properties of CxFy molecules
- 2. Measurement of total scattering cross section for e Ar, N2 collisions at low electron energies.
- 3. Calculation of total ionization cross section for e CxFy collisions
- 4. Diagnostic Plasma characteristics of CCP type
- 5. Surface reaction mechanism for processing plasma analysis (Sticking coefficient)
- 6. Group evaluation of NF3, NxOx



Summary

- 1. Molecular structure, physical and chemical parameters using Quantum Chemistry for low temperature plasma analysis.(CxFy species)
- 2. Measurement of total scattering cross section for e Molecules collisions and calculation collision processes.
- 3. Set of diagnostics data for HydroFluoroCarbon(HFC)/Ar/O2 plasma (Bulk plasmas)
- 4. Discover surface reaction mechanism for plasma etching processes (HydroFluoroCarbon(HFC))
- 5. Evaluated data of 68 gases and Group evaluated data (CH4, C2H2)

